

PRODUCT DATASHEET



- ► CSP CHIP LED
- ➤ 2020 0.94t Series
- ► Warm White (3000K)

N0W53S58





2020 0.94t Series





Release Date: 22 March 2021 Version: A1.0

FEATURES:

Package: Ceramic High Power CSP Package

Forward Current: 350~500mA Forward Voltage (typ.): 9.0V

Luminous Flux (typ.): 240lm@350mA

Colour: Warm White

CCT/Colour Temperature (typ.): 2800~3200K

Viewing angle: 115°

Materials:

Die: Flip-Chip InGaN

Resin: Silicon (Yellow Diffused)

L/T Finish: Ag plated

Operating Temperature: -40~+125°C Storage Temperature: -40~+125°C

Grouping parameters:

Forward Voltage

Luminous Flux

CIE Chromaticity

Soldering methods: IR Reflow

Preconditioning: MSL2 according to J-STD020

Packing: 8mm tape with Max.1000pcs /reel, ø180mm (7")

APPLICATIONS:

- Automotive Lightning
- **Decorative Lighting**
- Portable Lighting
- **Outdoor Lighting**
- **Commercial Lighting**
- **Indoor Lighting**
- **Industrial Lighting**



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	500	mA
Reverse Voltage	V _R	12	V
Junction Temperature	Tj	150	°C
Thermal Resistance Junction to Solder Point	R _{th(J-S)}	4	°C/W
Temperature Coefficient of Voltage		-2.5	mV/°C
Operating Temperature	T _{OPR}	-40~+125	°C
Storage Temperature	T _{STG}	-40~+125	°C
Colour Rendering Index / Ra	CRI	95	

Electrical & Optical Characteristics (Ta=25°C)

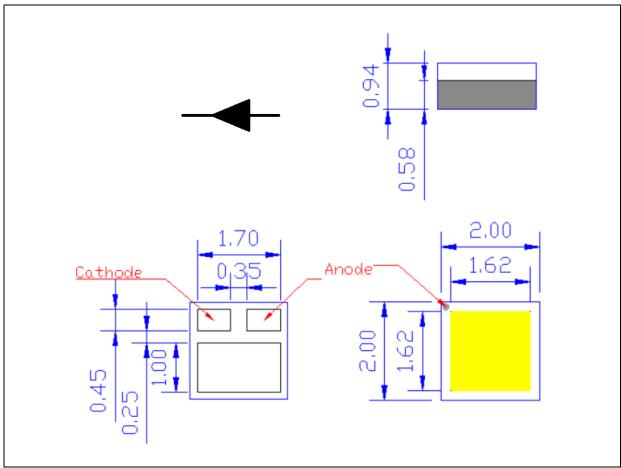
Parameter	Symbol	Values			Unit	Test
raiailletei	Зуппоп	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	V _F	8.5	9.0	10.0	V	I _F =350mA
Luminous Flux	Ф۷	220	240	260	lm	I _F =350mA
Chromaticity Coordinates	Х		0.4338			I _F =350mA
	Υ		0.4030			
ССТ		2800		3200	К	I _F =350mA
Viewing Angle	2θ _{1/2}		115		deg	I _F =350mA

^{1.} Luminous flux (Φ_V) ±7%, Forward Voltage (V_F) ±0.05V, Viewing angle($2\theta_{1/2}$) ±10°, CRI ±2



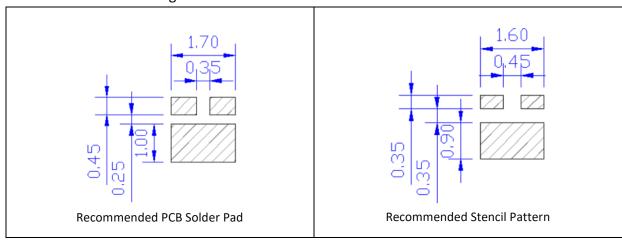
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.12mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 350mA):

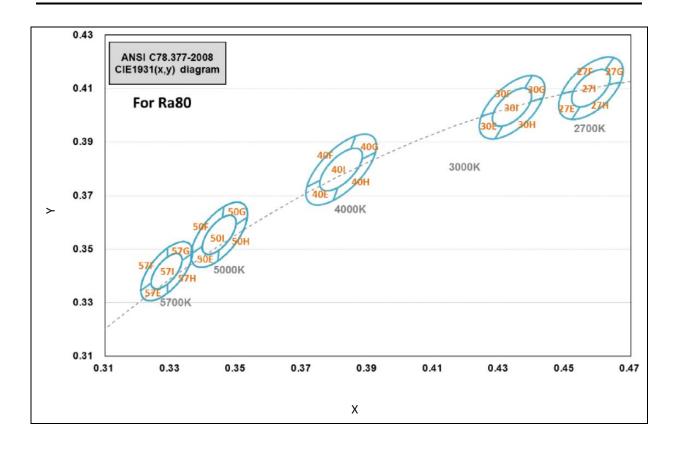
Code	Min.	Max.	Unit
ВР	8.5	8.8	
BQ	8.8	9.1	V
BR	9.1	9.4	V
BS	9.4	9.7	

Luminous Flux Classifications (I_F = 350mA):

Code	Min.	Max.	Unit	
U11	220	240	- Im	
U12	240	260		



CIE CHROMATICITY DIAGRAM:

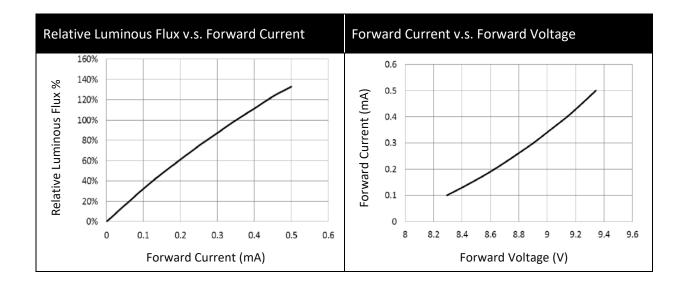


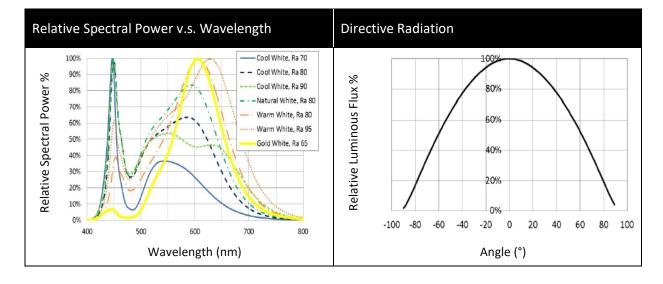
Chromaticity Coordinates Classifications (IF = 350mA):

	Cada	Centre		Radius		Angle
a /)	Code	Х	Υ	а	b	Ф
<u>р</u>	3-STEP	0.4338	0.4030	0.00834	0.00408	53.22
	5-STEP	0.4338	0.4030	0.01390	0.00680	53.22



ELECTRO-OPTICAL CHARACTERISTICS:

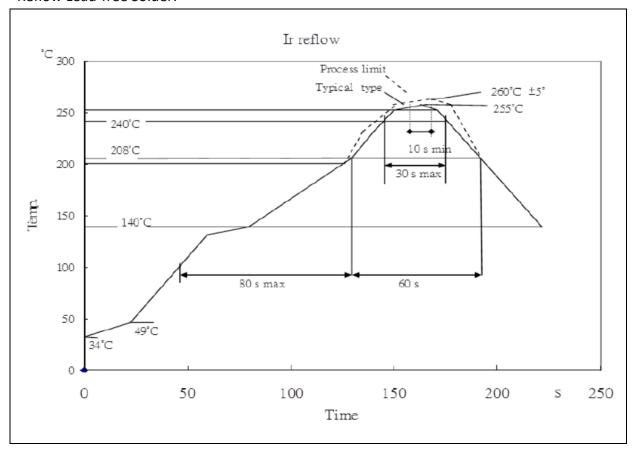






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



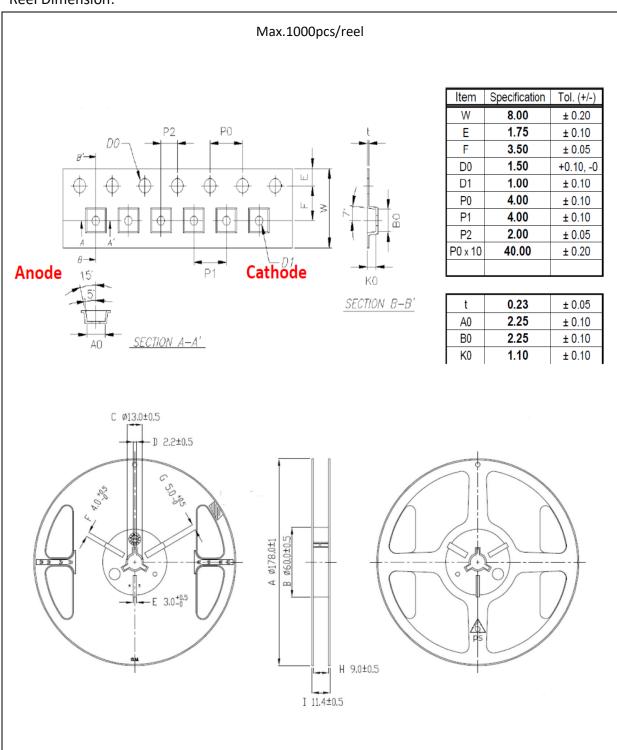
Note:

- 1. Maxima reflow soldering: 1 time.
- 2. The recommended reflow temperature is 240°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

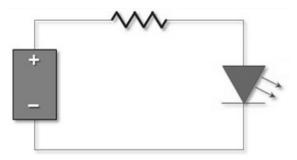
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	22/03/2021	Datasheet set-up.